E UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Applica

David A. Kiss

Serial No.:

10/017,031

Filed:

October 30, 2001

For:

**Packaged Combination Memory** 

for Electronic Devices

Box AF Commissioner for Patents Art Unit:

2815

Examiner:

Sheila Clark

Atty Docket: ITL.0696US

P13281

Washington, DC 20231

## REPLY TO FINAL REJECTION

Sir:

In response to the final office action mailed October 22, 2002, reconsideration is requested in view of the following remarks.

## REMARKS

Claim 1 calls for a circuit that is packaged and includes a processor, a volatile memory, and a cross point memory. Clearly and indisputably, the Mauritz patent does not teach a packaged structure. Mauritz is explicit for example, in the Figure on the first page, that different chips 24, 26, 22, and 12 are used. There is no indication of an intent to package the disparate memory elements into the same package.

With the single package solution, a one packaged component solves all problems approach may be provided. In other words, regardless of the application, a single packaged integrated circuit may be supplied and may be able to handle essentially any type of memory application. Packaging all of these different functionalities into the same package is no where suggested in Mauritz.

> Date of Deposit: November 4, 2002

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